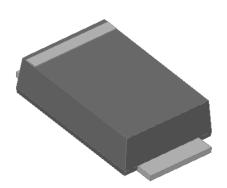




Surface Mount General Purpose Rectifier





Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

Typical Applications

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.

Mechanical Data

• Package: SMAF

Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free

- Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Polarity: Cathode line denotes the cathode end

■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	M1F	M2F	M3F	M4F	M5F	M6F	M7F
Device marking code			M1F	M2F	M3F	M4F	M5F	M6F	M7F
Repetitive peak reverse voltage	VRRM	V	50	100	200	400	600	800	1000
Average rectified output current @60Hz sine wave, resistance load, TL (Fig.1)	lo	Α	1.0						
Surge(non-repetitive)forward current @60Hz half-sine wave,1 cycle, Ta=25°C	IFSM	Α	30						
Storage temperature	Tstg	°C	-55~+150						
Junction temperature	Tj	°	-55~+150						

■Electrical Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	M1F	M2F	M3F	M4F	M5F	M6F	M7F
Maximum instantaneous forward voltage drop per diode	VF	>	IFM=1.0A	1.1						
Maximum DC reverse current	IRRM	μA	T _a =25°C		5.0					
at rated DC blocking voltage per diode @ VRM=VRRM	INKIVI	μΑ	T _a =125℃	100						

M1F THRU M7F

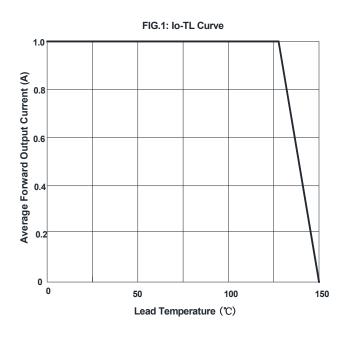
■Thermal Characteristics (Ta=25°C Unless otherwise specified)

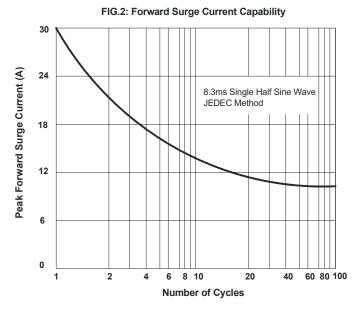
PARAMETER	SYMBOL	UNIT	M1F	M2F	M3F	M4F	M5F	M6F	M7F	
Typical Thermal resistance	RθJ-A ⁽¹⁾	2600	60 ¹⁾							
Typical Thermal resistance	RθJ-L ⁽¹⁾	°C/W	201)							

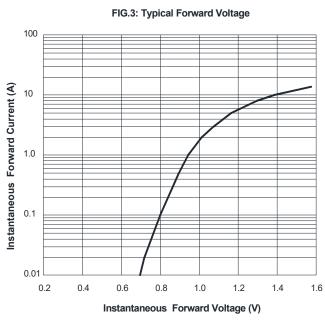
Note:

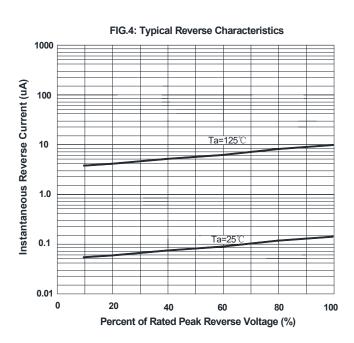
(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

■ Characteristics (Typical)









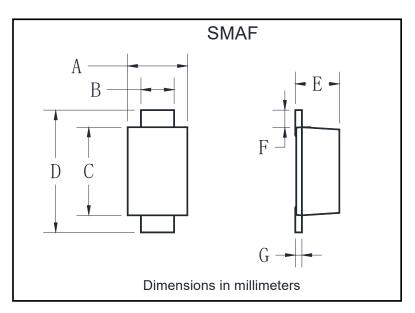


M1F THRU M7F

■Ordering Information (Example)

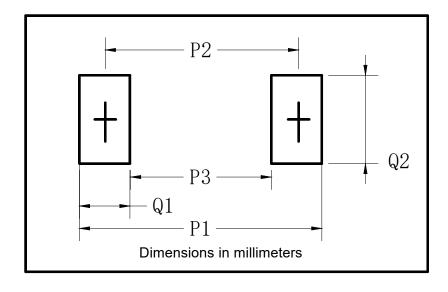
PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
M1F-M7F	F1	Approximate 0.034	3000	12000	96000	7" reel
M1F-M7F	F2	Approximate 0.034	10000	20000	160000	13" reel
M1F-M7F	F3	Approximate 0.034	10000	20000	120000	13" reel
M1F-M7F	F4	Approximate 0.034	7500	15000	120000	13" reel

■ Outline Dimensions



SMAF					
Dim	Min	Max			
Α	2.40	2.80			
В	1.35	1.45			
С	3.40	3.60			
D	4.40	4.80			
Е	1.05	1.25			
F	0.45	0.65			
G	0.15	0.22			

■ Suggested pad layout



SMAF				
Dim Millimeters				
P1	6.50			
P2	4.00			
P3	1.50			
Q1	2.50			
Q2	1.70			



M1F THRU M7F

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